

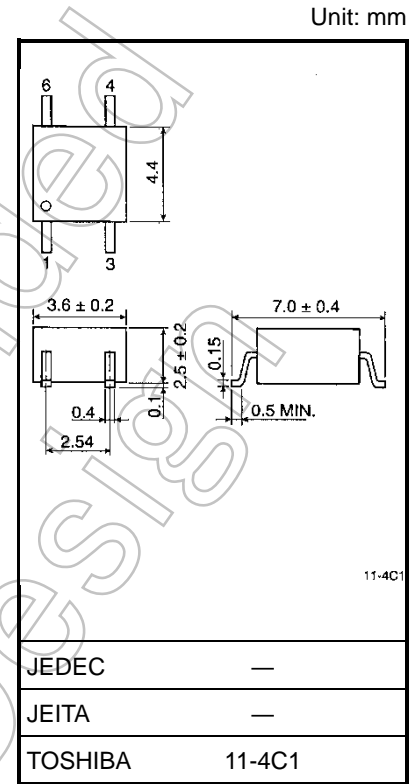
TLP173A

Telecommunications
 Control Equipment
 Data Acquisition System
 Security Equipment
 Measurement Equipment

The Toshiba TLP173A consists of an infrared emitting diode optically coupled to a photo-MOSFET in a MFSOP6 package. This photorelay requires 2 mA of LED current to turn it on. It is suitable for applications that need electrical power savings.

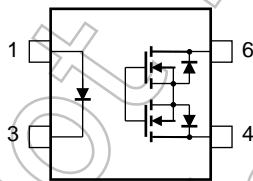
- 4-pin SOP (MFSOP6): Height = 2.5 mm, pitch = 2.54 mm
- Normally open (1-Form-A) device
- Peak off-state voltage: 60 V (min)
- Trigger LED current: 2 mA (max)
- On-state current: 70 mA (max)
- On-state resistance: 50 Ω (max)
- Isolation voltage: 3750 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

Note 1 : When a VDE approved type is needed, please designate the **Option(V4)**.



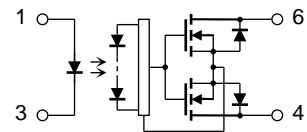
Weight: 0.09 g (typ.)

Pin Configuration (top view)



- 1: Anode
- 3: Cathode
- 4: Drain
- 6: Drain

Internal Circuit



Start of commercial production
 2009-11

Absolute Maximum Rating (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	A
	Reverse voltage	V _R	5	V
	Diode power dissipation	P _D	50	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C
	Junction temperature	T _j	125	°C
Detector	Off-state output terminal voltage	V _{OFF}	60	V
	On-state current	I _{ON}	70	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _{ON} /°C	-0.7	mA/°C
	Output power dissipation	P _O	196	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _O /°C	-1.96	mW / °C
	Junction temperature	T _j	125	°C
Storage temperature		T _{stg}	-55 to 125	°C
Operating temperature		T _{opr}	-40 to 85	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BVS	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.

Note 1: LED pins are shorted together. Detector pins are also shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V _{DD}	—	—	48	V
Forward current	I _F	—	3	25	mA
On-state current	I _{ON}	—	—	60	mA
Operating temperature	T _{opr}	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R = 5 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V_F = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	—	pF
Detector	Off-state current	I_{OFF}	$V_{OFF} = 60 \text{ V}$	—	1	1000	nA
	Capacitance	C_{OFF}	$V_{OFF} = 0 \text{ V}, f = 1 \text{ MHz}$	—	10	—	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I_{FT}	$I_{ON} = 70 \text{ mA}$	—	0.6	2	mA
Return LED current	I_{FC}	$I_{OFF} = 100 \mu\text{A}$	0.1	—	—	mA
On-state resistance	R_{ON}	$I_{ON} = 70 \text{ mA}, I_F = 3 \text{ mA}$	—	25	50	Ω

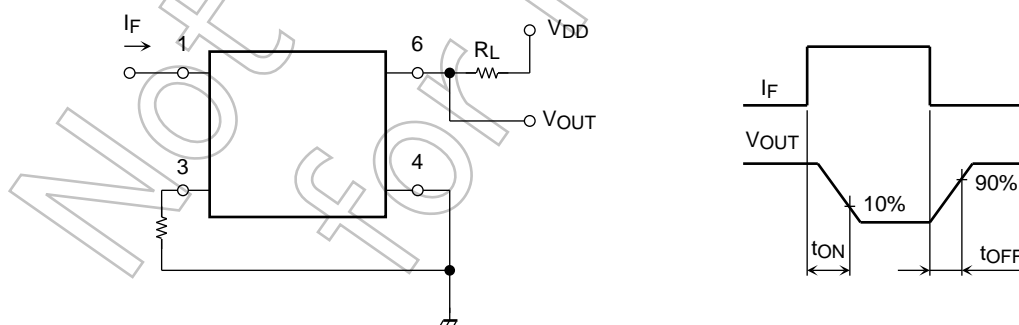
Isolation Characteristics (Ta = 25°C)

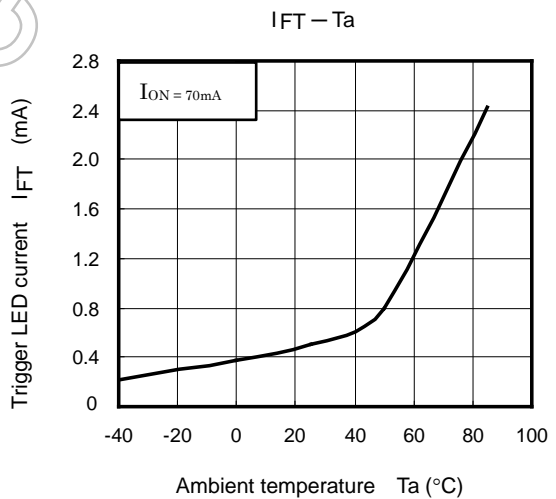
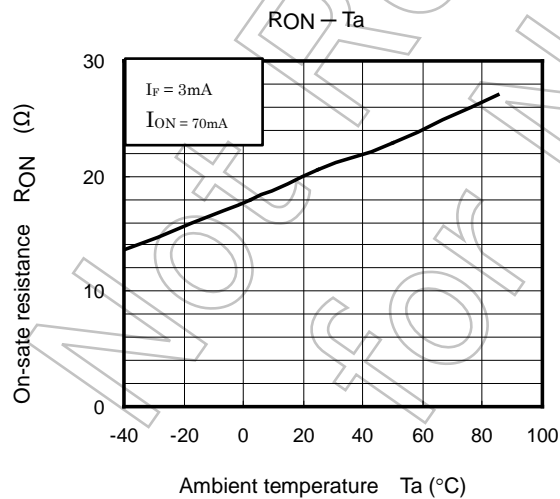
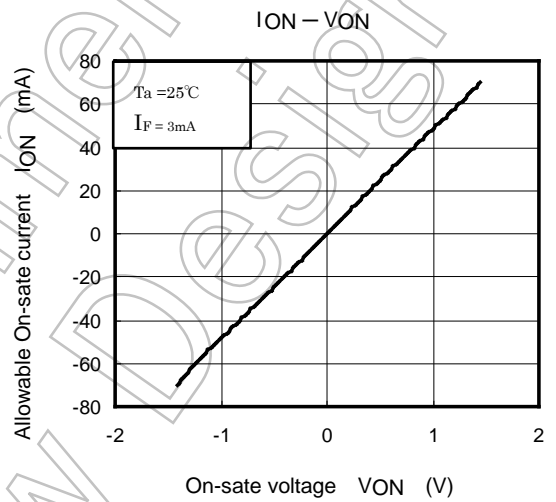
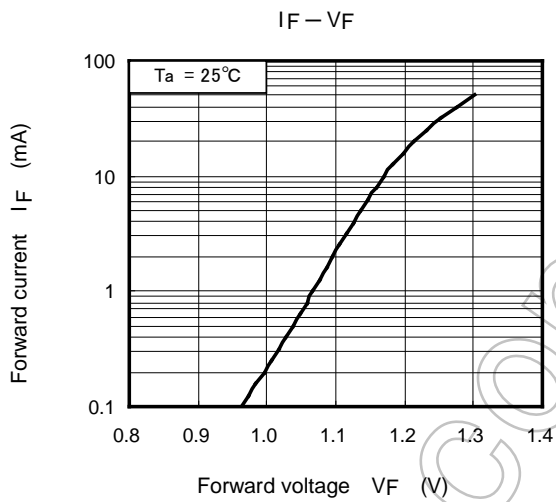
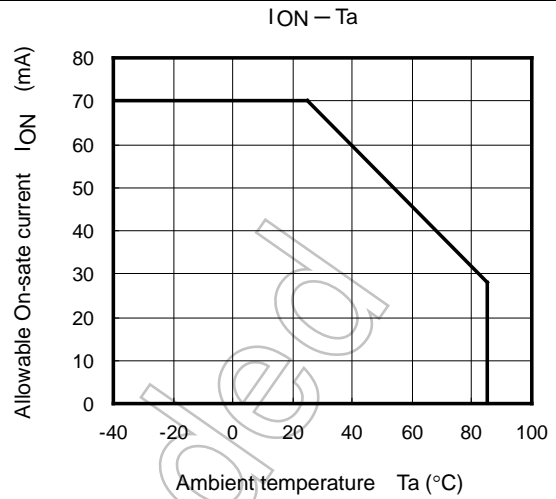
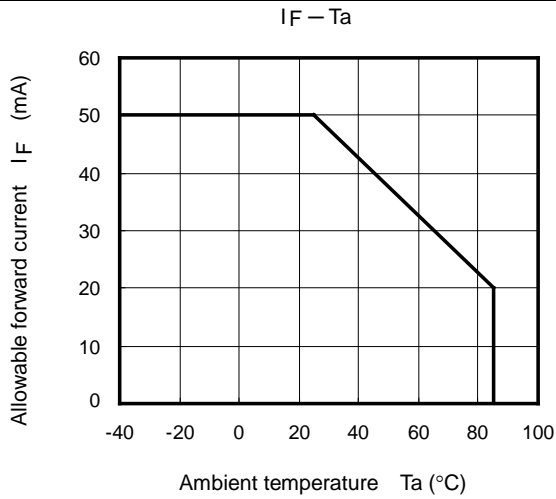
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.4	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, R.H. \leq 60 \%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	3750	—	—	Vrms

Switching Characteristics (Ta = 25°C)

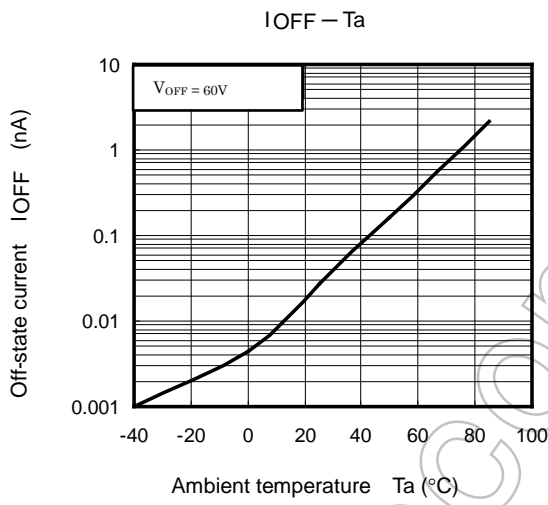
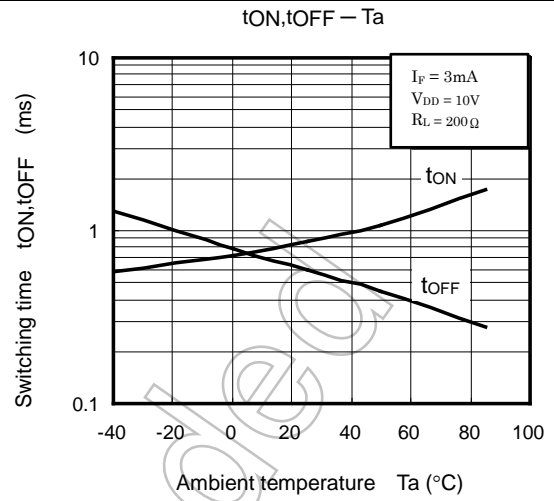
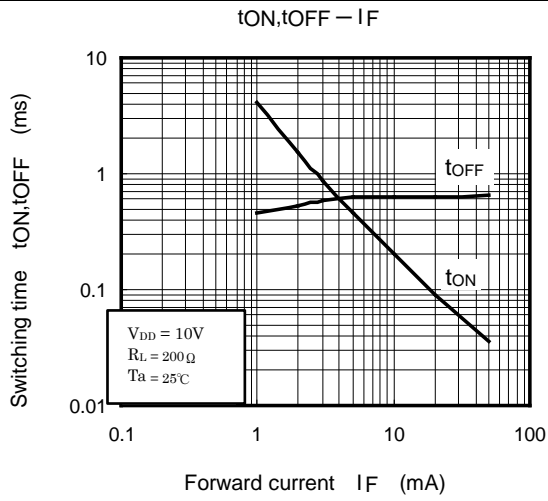
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$R_L = 200 \Omega$ (Note.2) $V_{DD} = 10 \text{ V}, I_F = 3 \text{ mA}$	—	1.0	5.0	ms
Turn-off time	t_{OFF}	$R_L = 200 \Omega$ (Note.2) $V_{DD} = 10 \text{ V}, I_F = 3 \text{ mA}$	—	0.5	5.0	

Note 2: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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Precautions about the Soldering of the SMD Type Photocoupler

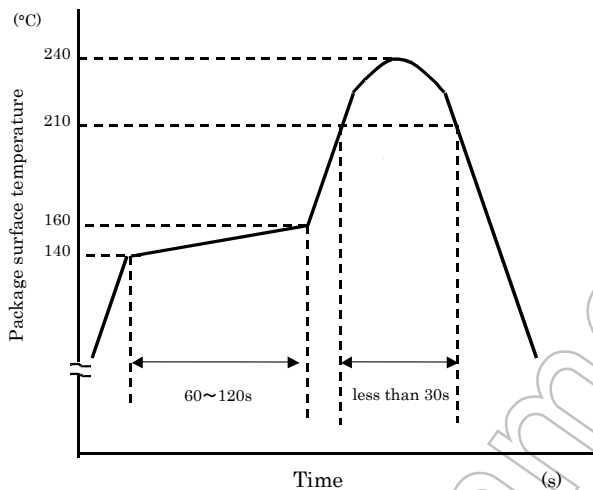
<Types>

TLP173A(F)

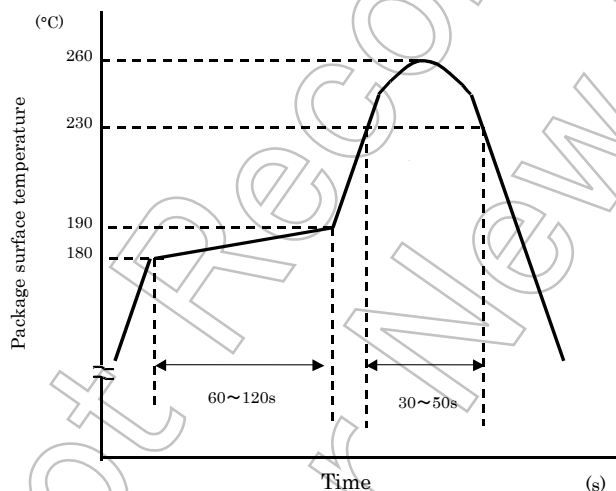
<Mounting Method>

1) Using Solder Reflow

- Temperature profile example of lead (Pb) solder



- Temperature profile example of using lead (Pb-free) solder



- The use of the reflow is to twice.
- In case of second reflow soldering should be performed within 2 weeks of the first reflow under the above conditions.

2) Using Solder Flow (for lead (Pb) solder, or lead (Pb)-free solder)

- Please preheat is at 150°C between 60 and 120 seconds.
- Complete soldering within 10 seconds below 260°C. Each pin may be heated at most once.
- The use of the reflow is to once.

3) Using a Soldering Iron

- Complete soldering within 10 seconds below 260°C, or within 3 seconds at 350°C. Each pin may be heated at most once.

Specification for Embossed-Tape Packing (TP) for Mini-Flat Coupler

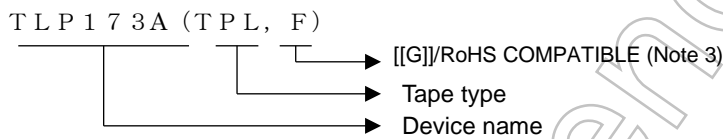
1. Applicable Package

Package	Product Type
MF-SOP6	Mini-Flat Coupler

2. Product Naming System

Type of package used for shipment is denoted by a symbol suffix after a product number. The method of classification is as below.

(Example)



3. Tape Dimensions

3.1 Specification Classification Are as Shown in Table 1

Table 1 Tape Type Classification

Tape type	Classification	Quantity (pcs / reel)
TPL	L direction	3000
TPR	R direction	3000

3.2 Orientation of Device in Relation to Direction of Tape Movement

Device orientation in the recesses is as shown in Figure 1.

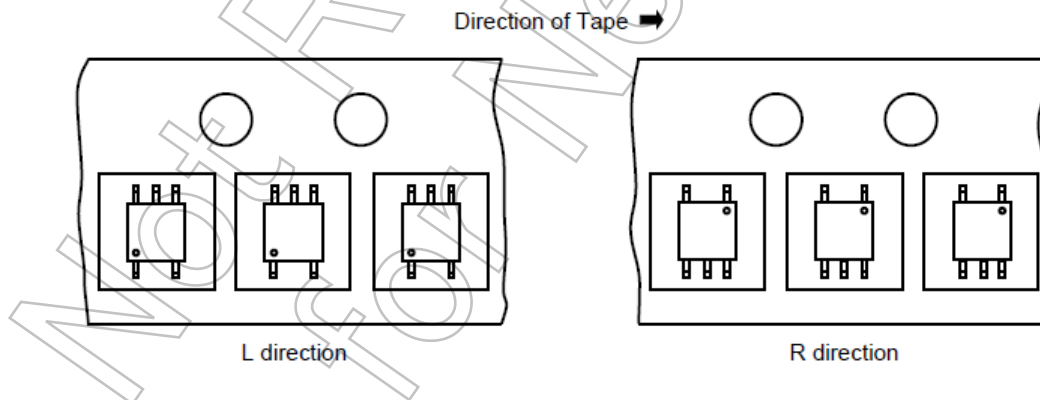


Figure 1 Device Orientation

3.3 Empty Device Recesses Are as Shown in Table 2.

Table 2 Empty Device Recesses

	Standard	Remarks
Occurrences of 2 or more successive empty device recesses	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty device recesses	6 device (max) per reel	Not including leader and trailer

3.4 Start and End of Tape

The start of the tape has 50 or more empty holes. The end of tape has 50 or more empty holes and two empty turns only a cover tape.

3.5 Tape Specification

- (1) Tape material: Plastic (protection against electrostatics)
- (2) Dimensions: The tape dimensions are as shown in Figure 2 and Table 3.

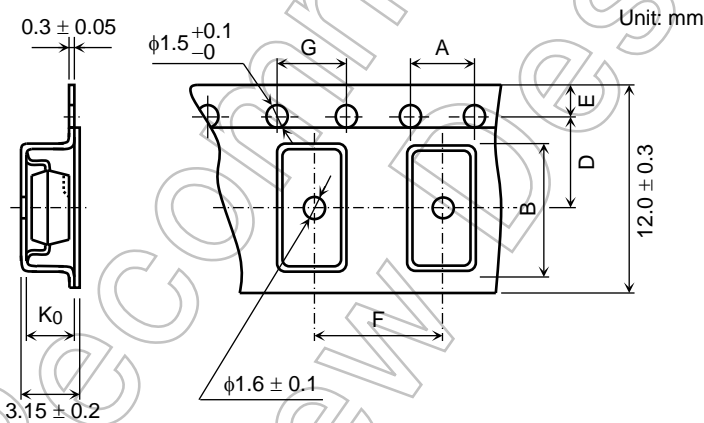


Figure 2 Tape Forms

Table 3 Tape Dimensions

Unit: mm
Unless otherwise specified: ±0.1

Symbol	Dimension	Remark
A	4.2	—
B	7.6	—
D	5.5	Center line of indented square hole and sprocket hole
E	1.75	Distance between tape edge and hole center
F	8.0	Cumulative error $\begin{matrix} +0.1 \\ -0.3 \end{matrix}$ per 10 feed holes
G	4.0	Cumulative error $\begin{matrix} +0.1 \\ -0.3 \end{matrix}$ per 10 feed holes
K ₀	2.8	Internal space

3.6 Reel

- (1) Material: Plastic
- (2) Dimensions: The reel dimensions are as shown in Figure 3 and Table 4.

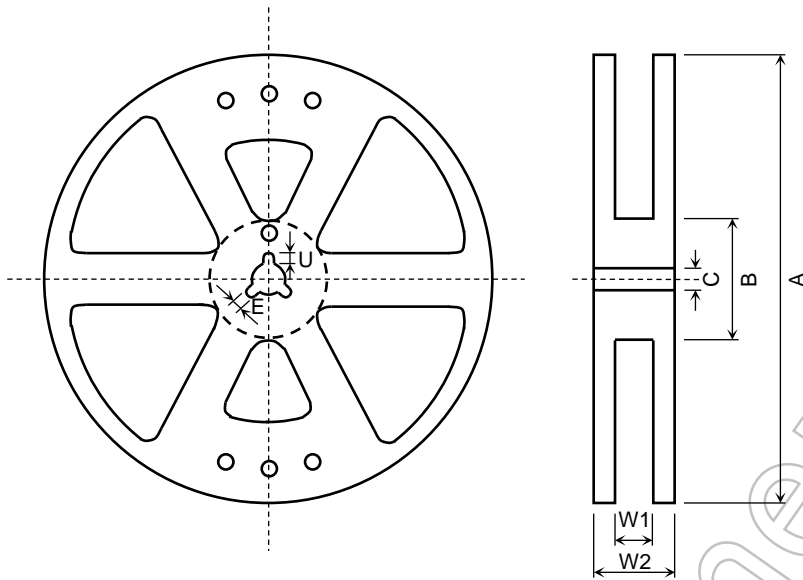


Figure 3 Reel Form

Table 4 Reel Dimensions

Unit: mm

Symbol	Dimension
A	$\Phi 330 \pm 2$
B	$\Phi 80 \pm 1$
C	$\Phi 13 \pm 0.5$
E	2.0 ± 0.5
U	4.0 ± 0.5
W1	13.5 ± 0.5
W2	17.5 ± 1.0

4. Packing

Packed in a shipping carton.

5. Label Indication

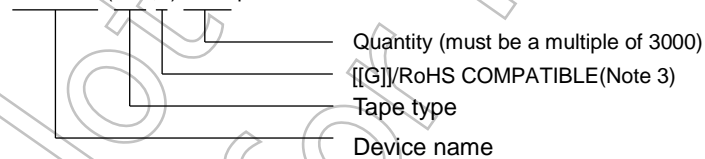
The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

6. Ordering Method

When placing an order, please specify the product number, the tape type and the quantity as shown in the following example.

(Example)

TLP173A (TPL,F) 3000 pcs



Note 3: Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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